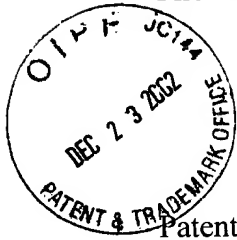


File No. DP990201

Dispatch No. 337198

Date of Dispatch: October 15, 2002

1/2



[Stamp: Miyazaki, 10/16/02, Mototsugu]

# NOTIFICATION OF REASONS FOR REJECTION

Patent Application No.: Patent Application No. 361546 of Heisei 11 [1999]  
Draft Date: October 3, 2002  
Patent Office Examiner: Kazumitsu Kudo 9274 5W00  
Agent of Patent Applicant: Chikara Miyazaki  
Applicable Sections: Section 29 (2)

RECEIVED  
DEC 27 2002  
TECHNOLOGY CENTER 2000

The present application should be rejected for the following reasons. If you have an opinion concerning this, please submit a statement of opinion within 60 days of the date of dispatch of this notification.

## Reasons

The inventions claimed in Claims 1 through 5 and 6 through 11 of the present application are inventions that could easily have been invented prior to the filing of the application by a person having an ordinary knowledge of the technical field to which the inventions belong on the basis of inventions described in Publications (1) through (4) listed below, which were disseminated in Japan or in foreign countries prior to the filing of the application. Thus, in accordance with the provisions of Section 29 (2) of the Patent Law, these inventions cannot be patented.

## Note

- (1) Japanese Patent Application Kokai No. H11-177374 (For example, see the description related to Figures 1 through 6)
- (2) CD-ROM of Japanese Utility Model Application No. H4-334 (Japanese Utility Model Application Kokai No. H5-59956 (For example, see the description related to Figures 3 and 4, regarding the sealing substrate)
- (3) Japanese Patent Application Kokai No. H4-4604 (For example, see the description related to Figures 1 and 2, regarding the low-temperature burning)
- (4) Japanese Patent Application Kokai No. H3-247010 (For example, see the description related to Figures 1 through 3)

Furthermore, it is recognized that Cited Example 1 and Cited Example 2 mentioned above indicate that the externally mounted substrate is a multi-layer substrate having at least one layer of an internal electrode.

## Record of Results of Survey of Prior Art References

- Field surveyed: IPC 7<sup>th</sup> Edition H 03 H 9/02

Please direct any inquiries regarding the content of this Notification of Reasons for Rejection, or any requests for an interview to:

[Stamp: —, 10/21/02, Hayashi]

Dispatch No. 337198

2/2

Patent Examination Department 4, Transfer Systems, TEL: 03 (3581) 1101, extension 3574